Product data sheet

1. Product profile

1.1 General description

Planar PIN diode in a SOD523 ultra small plastic SMD package.

1.2 Features and benefits

- High voltage, current controlled
- RF resistor for RF attenuators and switches
- Low diode capacitance
- Low diode forward resistance
- Very low series inductance
- For applications up to 6 GHz

1.3 Applications

RF attenuators and switches

2. Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Symbol
1	cathode [1]		14
2	anode	1 2	sym006

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
BAP64-02	-	plastic surface-mounted package; 2 leads	SOD523	



Silicon PIN diode

4. Marking

Table 3. Marking

Type number	Marking code
BAP64-02	S

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	175	V
l _F	forward current		-	100	mA
P _{tot}	total power dissipation	T _{sp} = 90 °C	-	715	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point		85	K/W

7. Characteristics

Table 6. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I _F = 50 mA	-	0.95	1.1	V
I _R	reverse current	V _R = 175 V	-	-	10	μΑ
		V _R = 20 V	-	-	1	μΑ
C _d	diode capacitance	see Figure 1; f = 1 MHz;				
		V _R = 0 V	-	0.48	-	pF
		V _R = 1 V	-	0.35	-	pF
		V _R = 20 V	-	0.23	0.35	pF

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 Table 6.
 Characteristics ...continued

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
r _D	diode forward resistance	see <u>Figure 2</u> ; f = 100 MHz; [1]				
		I _F = 0.5 mA	-	20	40	Ω
		I _F = 1 mA	-	10	20	Ω
		I _F = 10 mA	-	2.0	3.8	Ω
		I _F = 100 mA	-	0.7	1.35	Ω
τ∟	charge carrier life time	when switched from I_F = 10 mA to I_R = 6 mA; R_L = 100 Ω ; measured at I_R = 3 mA	-	1.55	-	μS
L _S	series inductance		-	0.6	-	nΗ

^[1] Guaranteed on AQL basis: inspection level S4, AQL 1.0.

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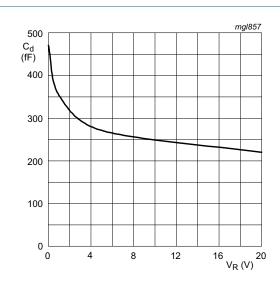


Fig 1. Diode capacitance as a function of reverse voltage; typical values

f = 1 MHz; $T_i = 25 \, ^{\circ}\text{C}$.

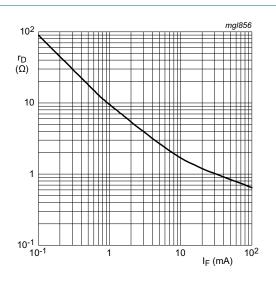
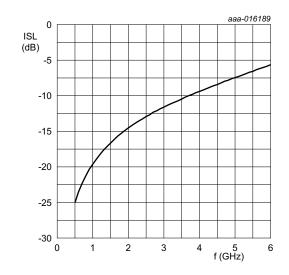


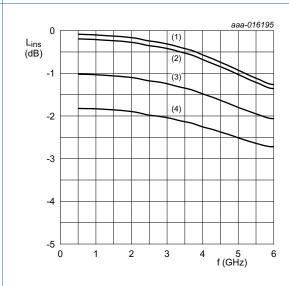
Fig 2. Forward resistance as a function of forward current; typical values

f = 100 MHz; $T_i = 25 \, ^{\circ}\text{C}$.



T_{amb} = 25 °C

Diode zero biased and inserted in series with a 50 Ω stripline circuit



T_{amb} = 25 °C

- (1) $I_F = 100 \text{ mA}$
- (2) $I_F = 10 \text{ mA}$
- (3) $I_F = 1 \text{ mA}$
- (4) $I_F = 0.5 \text{ mA}$

Diode inserted in series with a 50 Ω stripline circuit and biased via the analyzer Tee network

Fig 4. Insertion loss of the diode as a function of frequency; typical values

Fig 3. Isolation of the diode as a function of frequency; typical values

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8. Package outline

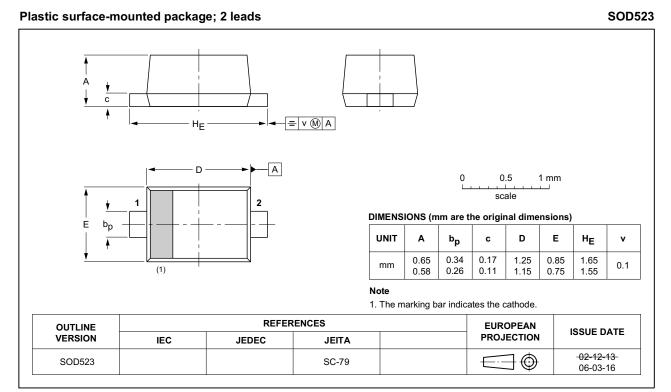


Fig 5. Package outline SOD523

9. Abbreviations

Table 7. Abbreviations

Acronym	Description
PIN	P-type, Intrinsic, N-type
SMD	Surface Mounted Device
RF	Radio Frequency

Silicon PIN diode

10. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAP64-02 v.9	20141215	Product data sheet	-	BAP64-02 v.8
Modifications:	Section 1.2	on page 1: The last item of the	list has been updated.	'
	• Figure 3 on	page 4: The figure now shows	a frequency range up to	o 6 GHz.
	• Figure 4 on	page 4: The figure now shows	a frequency range up t	o 6 GHz.
BAP64-02 v.8	20140428	Product data sheet	-	BAP64-02 v.7
BAP64-02 v.7	20140211	Product data sheet	-	BAP64-02_N v.6
BAP64-02_N v.6	20080109	Product data sheet	-	BAP64-02 v.5
BAP64-02 v.5 (9397 750 06912)	20000323	Product specification	-	BAP64-02 v.4
BAP64-02 v.4 (9397 750 06418)	19990921	Preliminary specification	-	BAP64-02_N v.3
BAP64-02_N v.3 (9397 750 06086)	19990616	Preliminary specification	-	BAP64-02 v.2
BAP64-02 v.2 (9397 750 05556)	19990510	Objective specification	-	BAP64-02_N v.1
BAP64-02_N v.1 (9397 750 05492)	19981204	Objective specification	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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BAP64-02

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